Applicant

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In the Claims:

This listing of claims will replace all prior versions and listings of claims in the application:

- 1. (Previously Presented) An optical sensor circuit assembly, comprising: an optically transmissive substrate including filter material; and an optical imaging element electrically coupled to said substrate.
- 2. (Original) The optical sensor circuit assembly of claim 1, wherein said filter material is embedded in said substrate.
- 3. (Original) The optical sensor circuit assembly of claim 1, wherein said filter material is dispersed in said substrate.
- 4. (Original) The optical sensor circuit assembly of claim 1, wherein said filter material comprises a thin film layer on said substrate.
- 5. (Original) The optical sensor circuit assembly of claim 4, wherein said thin film layer further comprises material having antireflective properties.
- 6. (Original) The optical sensor circuit assembly of claim 1, further comprising a circuit member coupled to a first surface of said substrate, said circuit member defining a plurality of electrically conductive leads.
- 7. (Original) The optical sensor circuit assembly of claim 6, wherein said optical imaging element includes an integrated circuit and a plurality of electrically conductive pads, said plurality of pads coupled with corresponding ones of said plurality of leads.
- 8. (Original) The optical sensor circuit assembly of claim 7, further comprising a conductive bump disposed between said plurality of leads and said plurality of pads.

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(Original) The optical sensor circuit assembly of claim 1, further comprising at least 9. one optical element positioned to direct electromagnetic radiation through said substrate and filter material and to said optical imaging element.

10. (Original) The optical sensor circuit assembly of claim 9, further comprising a lens mount supporting said at least one optical element and coupled to a second surface of said substrate.

- 11. (Canceled).
- 12. (Canceled).
- 13. (Canceled).
- (Canceled). 14.
- 15. (Canceled).
- 16. (Canceled).
- 17. (Canceled).
- (Canceled). 18.
- (Canceled). 19.